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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/562,528	12/28/2005	Xue-Jan Fan	US030215	7980
PHILIPS INTELLECTUAL PROPERTY & STANDARDS P.O. BOX 3001			EXAMINER	
			SMITH, COURTNEY L	
BRIARCLIFF	RIARCLIFF MANOR, NY 10510		ART UNIT	PAPER NUMBER
			2835	
			MAIL DATE	DELIVERY MODE
			12/10/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)				
	10/562,528	FAN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Courtney L. Smith	2835				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address						
Period for Reply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS,						
<ul> <li>A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA</li> <li>Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.</li> <li>If NO period for reply is specified above, the maximum statutory period w</li> <li>Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).</li> </ul>	ATE OF THIS COMMUNI 16(a). In no event, however, may a rill apply and will expire SIX (6) MOI cause the application to become Al	CATION. reply be timely filed  NTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 28 De						
,—						
,	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims						
4)⊠ Claim(s) <u>1-20</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6) Claim(s) <u>1-20</u> is/are rejected.						
7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	r election requirement					
O/ Claim(s) are subject to restriction unarel election requirement.						
Application Papers						
9) The specification is objected to by the Examiner.						
10) ☐ The drawing(s) filed on <u>28 December 2005</u> is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.						
		c				
Attachment(s)						
1) Notice of References Cited (PTO-892)		Summary (PTO-413) (s)/Mail Date				
<ol> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO/SB/08)         Paper No(s)/Mail Date 12/28/2005.     </li> </ol>		Informal Patent Application				

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### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the second paragraph of 35 U.S.C. 112:
  - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claims 1-10, 14-16, 18, 20 rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 3. Claims 1-10, 14-16, 18, 20 recites the limitation "the substrate 110" in respective claims. There is insufficient antecedent basis for this limitation in the claims.

# Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 2. Claim 1 rejected under 35 U.S.C. 102(b) as being anticipated by (Mazzochette 7,095,053).

Regarding Claim 1, Mazzochette discloses a device (Fig. 6) for thermal management of an LED (10), the device comprising: a heat sink (51); a substrate (17) overlying the

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heat sink; a trace layer (col. 6, lines 35-37) overlying the substrate; and a via (56) extending through the substrate, wherein the via is in thermal communication with the trace layer and the heat sink to transfer to the heat sink at least a portion of any heat applied to the trace layer by the LED.

Regarding Claim 2, Mazzochette discloses a device (Fig. 6) of claim 1, further comprising: a bonding layer (Col. 4, lines 7-11) between the substrate and the via.

Regarding Claims 3-5, Mazzochette discloses a device (Fig. 6) of claim 2, wherein the bonding layer is a thermally conductive tape on a multi-layered substrate (Col. 7, lines 4-10).

Regarding Claim 6, Mazzochette discloses a device (Fig. 6) of claim 1, wherein the substrate is a printed circuit board (Col. 2, lines 60-63).

Regarding Claim 7, Mazzochette discloses a device (Fig. 6) of claim 1, wherein the substrate is a flexible substrate (Col. 8, lines 58-59).

Regarding Claim 12, Mazzochette discloses a device (Fig. 6) for thermal management of an LED (10), the device comprising: a heat sink (51); a trace layer (Col. 3, lines 5-9); and a flexible substrate (Col. 8, lines 58-59) in thermal communication with the trace

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layer and the heat sink to transfer to the heat sink any heat applied to the trace layer by the LED.

Regarding Claim 13, Mazzochette discloses a device (Fig. 6) of claim 12, further comprising: a via (56) extending through the substrate, wherein the via is in thermal communication with the trace layer and the heat sink to enhance the transfer to the heat sink of any heat applied to the trace layer by the LED.

### Claim Rejections - 35 USC § 103

3. Claims 8-11, 14-20 rejected under 35 U.S.C. 103(a) as being unpatentable over (Maxxochette 7,095,053) as applied to claim 1 above, in view of (Nakamura 7,054,159) Claims 8-11, Mazzochette discloses a device (Fig. 6) of claim 1, except explicitly disclosing the via includes: a sidewall defining a channel through the substrate, the channel interfacing with the trace layer to thereby establish the thermal communication between the via, trace layer and heat sink. However, Nakamura discloses a sidewall (copper foil--5a-fig. 2) defining a channel (5) through the substrate (2), the channel interfacing with the trace layer (2a, 2b) to thereby establish the thermal communication between the via, trace layer, and heat sink (4). It would have been obvious to one having ordinary skill in the art at the time that the invention was made to provide the device of Mazzochette with the via of Nakamura in order to increase the

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surface area of the via; wherein allowing for more effective heat transfer and bypassing the circuit board.

Regarding Claims 14-17, Mazzochette discloses a device (Fig. 6) of claim 1, except explicitly disclosing the via includes: a sidewall defining a channel through the substrate, the channel interfacing with the trace layer to thereby establish the thermal communication between the via, trace layer and heat sink. However, Nakamura discloses a sidewall (copper foil--5a-fig. 2) including defining a channel (5) through the substrate (2), the channel interfacing with the trace layer (2a, 2b) to thereby establish the thermal communication between the via, trace layer, and heat sink (4). It would have been obvious to one having ordinary skill in the art at the time that the invention was made to provide the device of Mazzochette with the via of Nakamura in order to increase the surface area of the via; wherein allowing for more effective heat transfer and bypassing the circuit board.

Regarding Claims 18-19, Mazzochette discloses a device (Fig. 6) for thermal management of an LED (10), the device comprising: a heat sink (51); a substrate (17) overlying the heat sink, a trace layer (Col. 3, lines 5-9) overlying the substrate; and a via (56) except explicitly disclosing the via includes: a sidewall defining a channel through the substrate, the channel interfacing with the trace layer to thereby establish the thermal communication between the via, trace layer and heat sink. However, Nakamura discloses a sidewall (copper foil--5a-fig. 2) including defining a channel (5)

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through the substrate (2), the channel interfacing with the trace layer (2a, 2b) to thereby establish the thermal communication between the via, trace layer, and heat sink (4). It would have been obvious to one having ordinary skill in the art at the time that the invention was made to provide the device of Mazzochette with the via of Nakamura in order to increase the surface area of the via; wherein allowing for more effective heat transfer and bypassing the circuit board.

Regarding Claim 20, Mazzochette discloses a device (Fig. 6) of claim 18, further comprising: a bonding layer (Col. 7, lines 4-10) between the substrate and the via.

### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Courtney L. Smith whose telephone number is 571-272-9094. The examiner can normally be reached on Monday-Friday 7:30a-5p (1st Fri. off).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jayprakash Gandhi can be reached on 571-272-3740. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only.

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Courtney L Smith Examiner

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BORIS CHÉRVINSKY PRIMARY EXAMINER

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